



Image

2829

PATENT

I hereby certify that on the date specified below, this correspondence is being deposited with the United States Postal Service as first-class mail in an envelope addressed to Mail Stop Non-Fee Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

February 11, 2004  
Date

Denise Sheridan  
Denise Sheridan

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/057,205                      Confirmation No. : 1725  
Applicants : Sion C. Quinlan and Tim J. Bales  
Filed : January 25, 2002                      Attorney Docket No.: 500986.02  
Art Unit : 2829                      Customer No. : 27,076  
Examiner : Scott B. Geyer  
Title : SEMICONDUCTOR PACKAGE ASSEMBLY AND METHOD FOR ELECTRICALLY  
ISOLATING MODULES

Mail Stop Non-Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT

Sir:

Applicants acknowledge receipt of the Office Action dated December 22, 2003.  
Please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on  
page 5 of this paper.

Remarks begin on page 8 of this paper.